

Primary Characteristics

I_F	1	A
V_{RRM}	50~1000	V
I_{FSM}	30	A
V_F	1.0~1.70	V

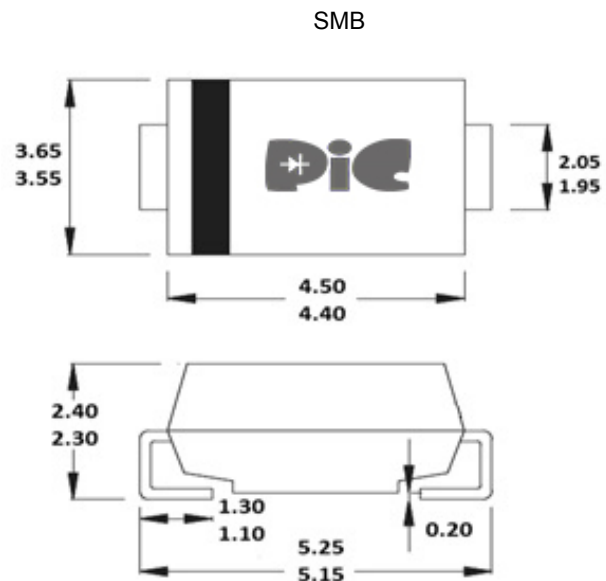
Features

- Low profile package
- Ideal for automated placement
- Low reverse current
- Fast reverse recovery time
- Component in accordance to RoHS 2002/95/EC

Mechanical Data

- Case: DO-214AA(SMB)
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Terminals: Lead free Plating (Tin Finish)
Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band
- Weight: 0.095 grams (approximate)

Package Outline Dimensions



Dimensions in inches and millimeters

Maximum Ratings (TA=25°C unless otherwise noted)

PARAMETER	SYMBOL	US1AB	US1BB	US1DB	US1GB	US1JB	US1KB	US1MB	UNIT	
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V	
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	700	V	
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	V	
Maximum average forward rectified current	I_F	1.0							A	
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I_{FSM}	30.0							A	
Maximum Instantaneous Forward Voltage $I_F=1A @ 25^\circ C$	V_F	1.0		1.3		1.7			V	
Maximum DC Reverse Current @ $T_c=25^\circ C$ at Rated DC Blocking Voltage @ $T_c=100^\circ C$	I_R	5 100							μA	
Typical Junction Capacitance(NOTE1)	C_j	20							pF	
Maximum Reverse Recovery Time(NOTE2)	T_{rr}	50.0				75.0				ns
Typical Thermal Resistance(NOTE3)	$R_{\theta Ja}$	80							$^\circ C/W$	
Operating Temperature Range	T_J	-55 to +150							$^\circ C$	
Storage Temperature Range	T_{STG}	-55 to +150							$^\circ C$	

NOTES:

1. Measured at 1.0MHZ and applied reverse voltage of 4.0V DC
2. Measured with $I_F=0.5A$, $I_R=1A$, $IRR=0.25A$
3. Device mounted on FR-4 substrate, 1"×1", 2oz, single-sided, PC boards with 0.1"×0.15" copper pad.

Rating and Characteristics Curves

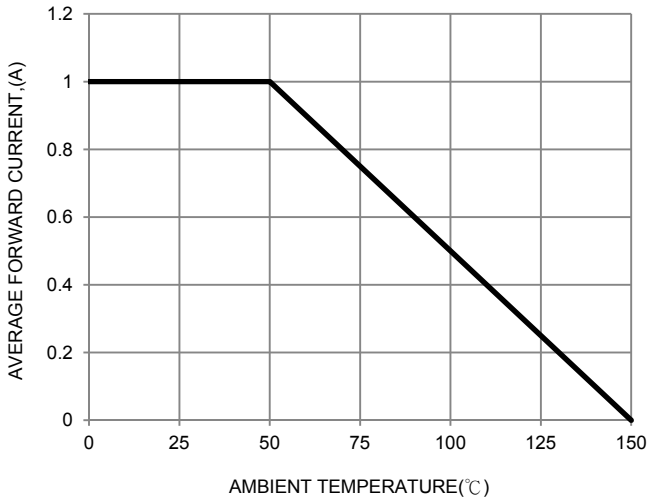


FIG. 1-Typical Forward Current Derating Curve

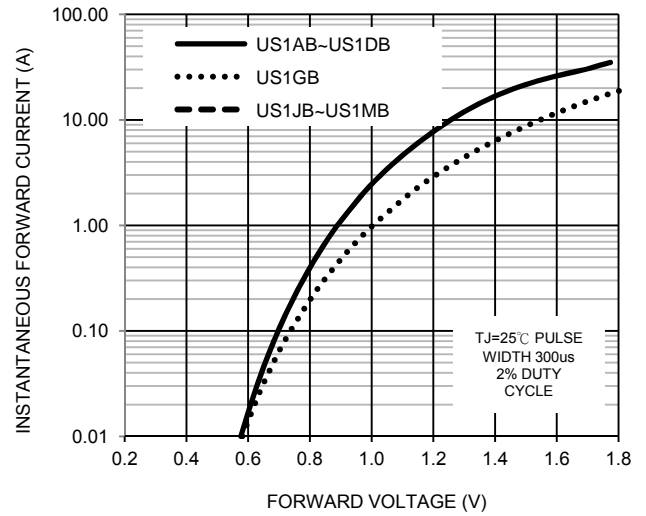


FIG. 2-Typical Forward Characteristics

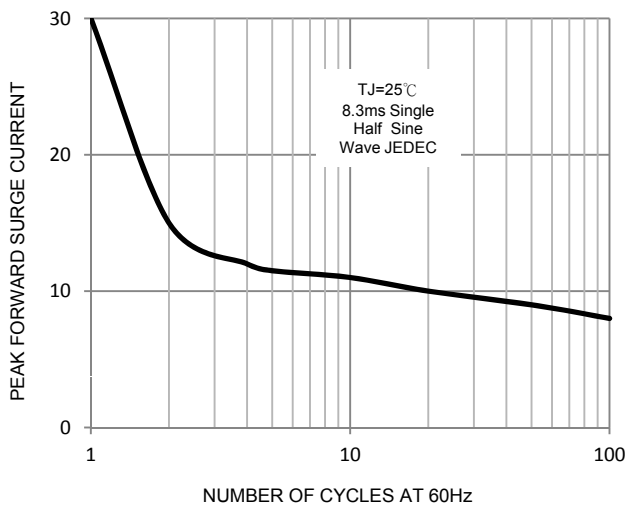


FIG. 3-Maximum Non-Repetitive Forward Surge Current

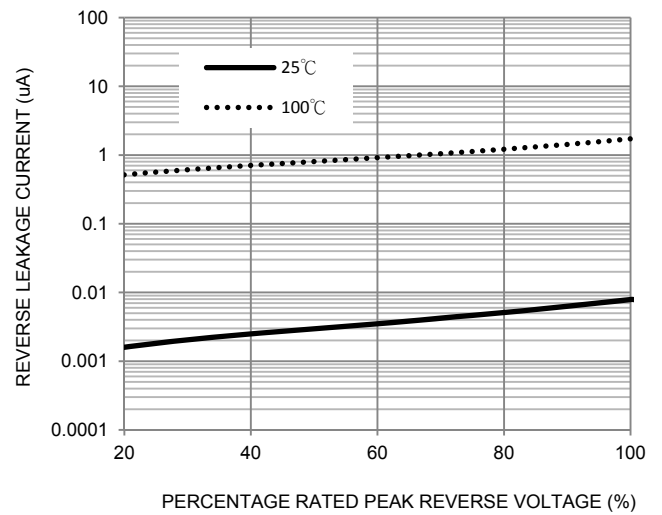


FIG. 4-Typical Reverse Characteristics

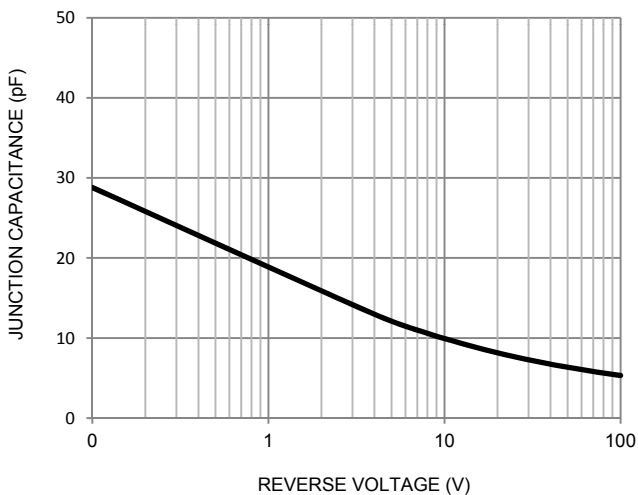


FIG. 5-Typical Junction Capacitance

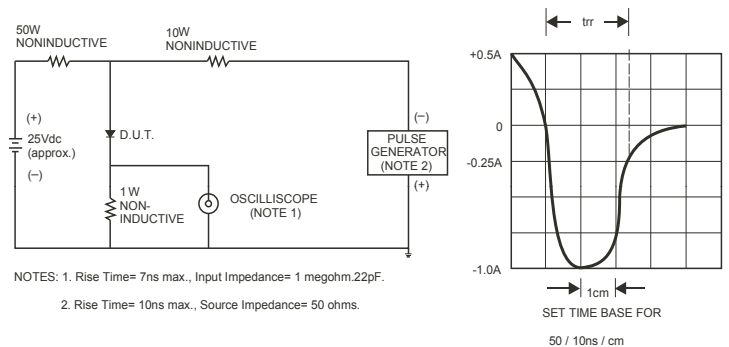
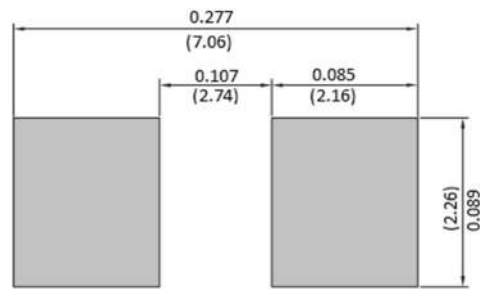


FIG. 6-Reverse Recovery Time Characteristic and Test Circuit

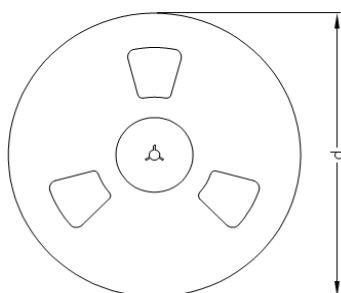
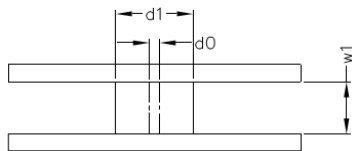
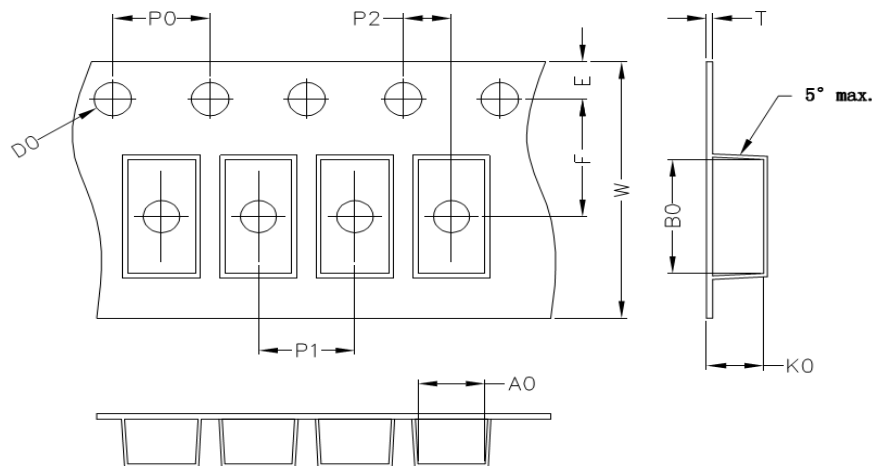
Pad Layout



Unit: mm

Packaging Specifications

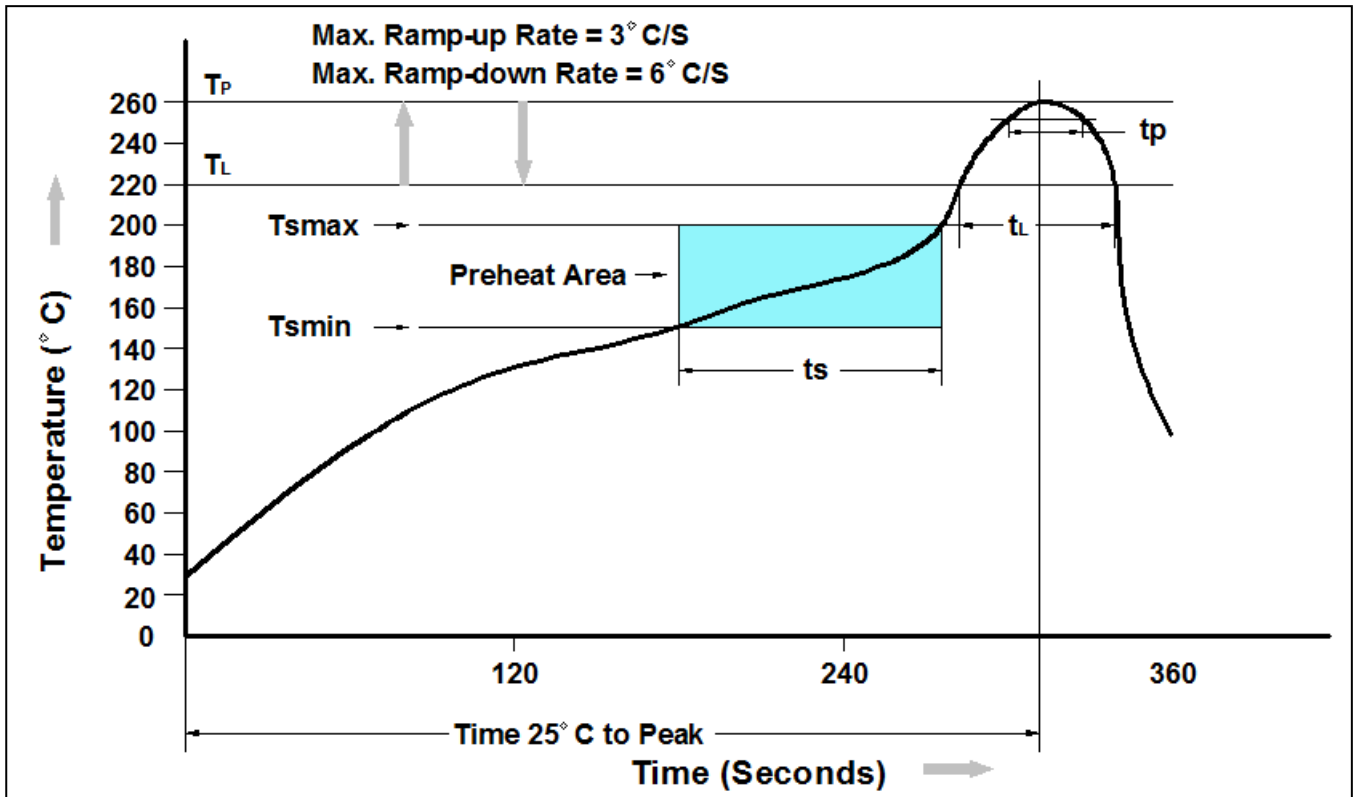
Package	A0 (mm)	B0 (mm)	K0 (mm)	D0 (mm)	E (mm)	F (mm)	P0 (mm)	P1 (mm)	P2 (mm)	T (mm)	W (mm)
SMA	2.8±0.1	5.33±0.1	2.36±0.1	1.55±0.1	1.75±0.1	5.50±0.1	4.0±0.1	4.0±0.01	2±0.1	0.25±0.1	9.4±0.1
SMB	3.8±0.1	5.40±0.1	2.45±0.1	1.55±0.1	1.75±0.1	5.50±0.1	4.0±0.1	8.0±0.01	2±0.1	0.25±0.1	9.4±0.1
SMC	6.05±0.1	8.31±0.1	2.54±0.1	1.55±0.1	1.75±0.1	7.50±0.1	4.0±0.1	8.0±0.05	2±0.1	0.25±0.1	12±0.1



Package	D1 (mm)	D0 (mm)	W1 (mm)	D (mm)
SMA	75	13.5	13.5	330
SMB	75	13.5	13.5	330
SMC	75	13.5	17.0	330

NOTE : The tolerance of reel is ±2mm

Recommend IR Reflow Soldering Thermal Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (T_{smin})	150°C
Temperature Max. (T_{smax})	200°C
Time (t_s) from (T_{smin} to T_{smax})	60-120 seconds
Average Ramp-up Rate (t_L to t_P)	3°C/second max.
Liquidous Temperature (T_L)	217°C
Time (t_L) Maintained Above (T_L)	60 – 150 seconds
Peak Temperature	260°C +0°C / -5°C
Time (t_P) within 5°C of actual Peak Temperature	30 seconds
Ramp-down Rate (T_P to T_L)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.

Ordering Information

Part Number	Description	Quantity
US1AB~US1MB	SMB Reel	3000 pcs

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